

6MBI150VX-120-50

IGBT Modules

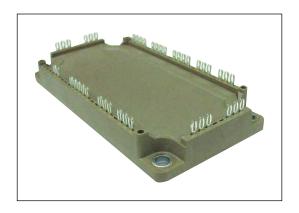
IGBT MODULE (V series) 1200V / 150A / 6 in one package

■ Features

Compact Package P.C.Board Mount Low Vce (sat)

■ Applications

Inverter for Motor Drive
AC and DC Servo Drive Amplifier
Uninterruptible Power Supply
Industrial machines, such as welding machines



■ Maximum Ratings and Characteristics

● Absolute Maximum Ratings (at Tc=25°C unless otherwise specified)

Items		Symbols	Conditions		Maximum ratings	Units	
	Collector-Emitter voltage		Vces			1200	V
	Gate-Emitter v	ate-Emitter voltage				±20	V
rter	Collector current		Ic	Continuous	Tc=80°C	150	
ert			Icp	1ms	Tc=80°C	300	^
Inve			-lc			150	Α
			-lc pulse	1ms		300	
	Collector power dissipation		Pc	1 device		770	W
Junction temperature		Tj			175		
Operating junciton temperature (under switching conditions)			Tjop			150	°C
Case temperature		Тс	125				
Storage temperature		Tstg	-40 to +125				
Iso	lation voltage	between terminal and copper base (*1) between thermistor and others (*2)	Viso	AC : 1min.		2500	VAC
Sc	rew torque	Mounting (*3)	-	M5		3.5	N m

Note *1: All terminals should be connected together during the test.

Note *2: Two thermistor terminals should be connected together, other terminals should be connected together and shorted to base plate during the test.

Note *3: Recommendable value: 2.5-3.5 Nm (M5)

● Electrical characteristics (at Tj= 25°C unless otherwise specified)

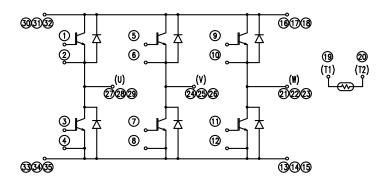
Items		Symbols	Conditions		Characteristics			Units
		Symbols			min.	typ.	max.	Units
	Zero gate voltage collector current	Ices	V _{GE} = 0V, V _{CE} = 1200V		-	-	1.0	mA
	Gate-Emitter leakage current	Iges	$V_{GE} = 0V$, $V_{GE} = \pm 20V$		-	-	200	nA
	Gate-Emitter threshold voltage	V _{GE (th)}	V _{CE} = 20V, I _C = 150mA		6.0	6.5	7.0	V
		V _{CE (sat)} (terminal)	V _{GE} = 15V I _C = 150A	Tj=25°C	-	2.50	2.95	V
	Collector-Emitter saturation voltage			Tj=125°C	-	2.80	-	
				Tj=150°C	-	2.85	-	
		V _{CE (sat)} (chip)	V _{GE} = 15V I _C = 150A	Tj=25°C	-	1.75	2.20	
Inverter				Tj=125°C	-	2.05	-	
				Tj=150°C	-	2.10	-	
	Input capacitance	Cies	V _{CE} = 10V, V _{GE} = 0V, f = 1MHz		-	13.7	-	nF
	Turn-on time	ton	$V_{CC} = 600V$ $I_{C} = 150A$ $V_{GE} = +15 / -15V$ $R_{G} = 1.1\Omega$		-	0.39	1.20	μs
		tr			-	0.09	0.60	
		tr (i)			-	0.03	-	
		toff			-	0.53	1.00	
	Turn-off time	tf			-	0.06	0.30	
		V _F (terminal)	I _F = 150A	Tj=25°C	-	2.45	2.90	V
	Forward on voltage			Tj=125°C	-	2.60	-	
				Tj=150°C	-	2.55	-	
			I _F = 150A	Tj=25°C	-	1.70	2.15	
		V _F (chip)		Tj=125°C	-	1.85	-	
				Tj=150°C	-	1.80	-	
	Reverse recovery time	trr	I _F = ±20		-	-	0.1	μs
jo		R	T = 25°C		-	5000	-	Ω
Thermistor	Resistance		T = 100°C		465	495	520	
The	B value	В	T = 25 / 50°C		3305	3375	3450	K

● Thermal resistance characteristics

Items	Symbols	Conditions	Characteristics			Units
items		Conditions	min.	typ.	max.	Ullits
harmal registance (Adayisa)	Rth(j-c)	Inverter IGBT	-	-	0.195	°C/W
Thermal resistance (1device)		Inverter FWD	-	-	0.34	
Contact thermal resistance (1device) (*4)	Rth(c-f)	with Thermal Compound	-	0.05	-	

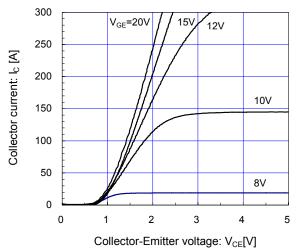
Note *4: This is the value which is defined mounting on the additional cooling fin with thermal compound.

■ Equivalent Circuit Schematic

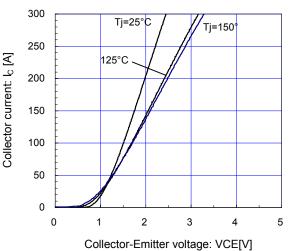


■ Characteristics (Representative)

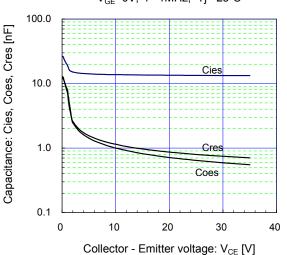
 $[\ Inverter\]$ Collector current vs. Collector-Emitter voltage (typ.) $Tj{=}\ 25^{\circ}C\ /\ chip$



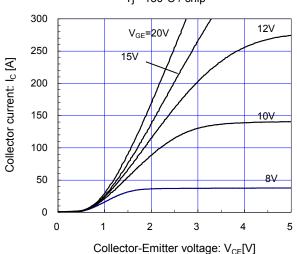
 $[\ Inverter\]$ Collector current vs. Collector-Emitter voltage (typ.) $V_{GE} {=} 15V\ /\ chip$



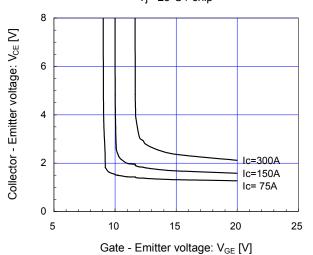
 $[Inverter\,] $$ Capacitance vs. Collector-Emitter voltage (typ.) $$ V_{GF}=0V, f= 1MHz, Tj= 25^{\circ}C $$$



[Inverter]
Collector current vs. Collector-Emitter voltage (typ.)
Tj= 150°C / chip



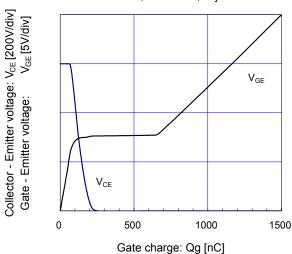
 $[Inverter\] \\ Collector-Emitter\ voltage\ vs.\ Gate-Emitter\ voltage\ (typ.) \\ Tj=25^{\circ}C\ /\ chip$

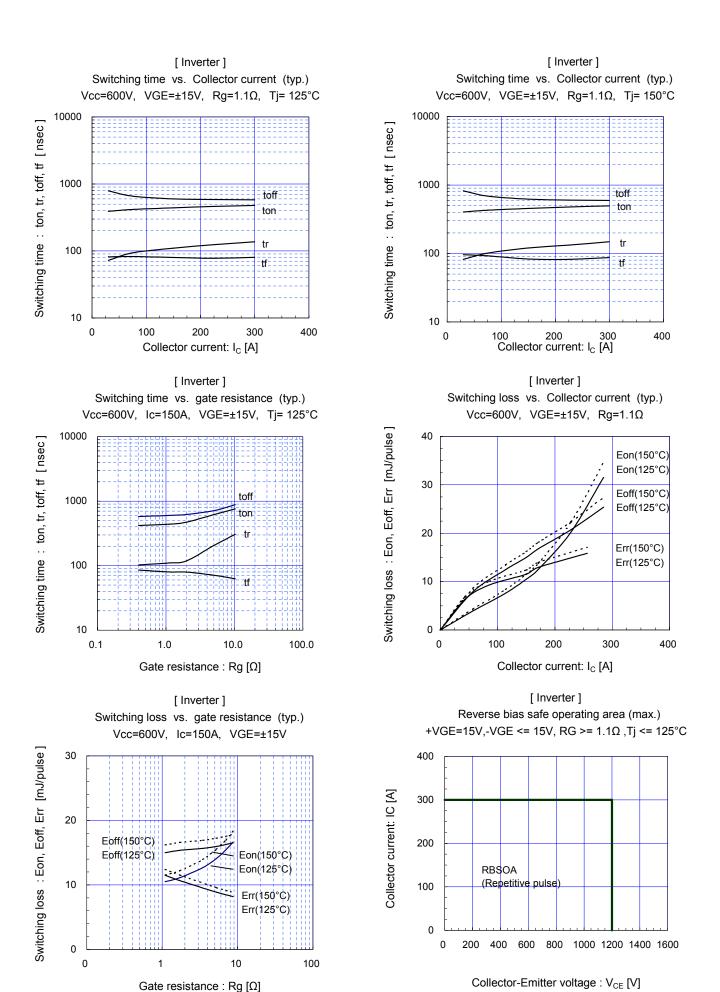


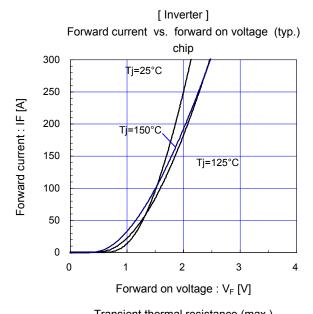
[Inverter]

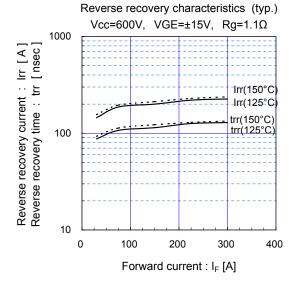
Dynamic gate charge (typ.)

Vcc=600V, Ic=150A, Tj= 25°C

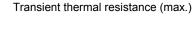


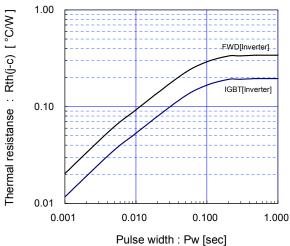


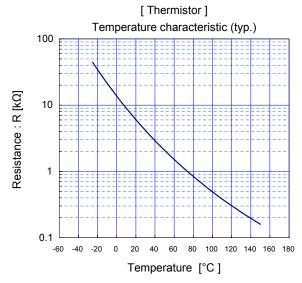




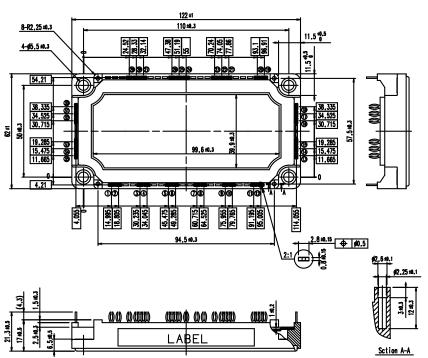
[Inverter]







■ Outline Drawings, mm



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